

Features

- Low $V_{CE(sat)}$
- Fast Switching
- High Ruggedness
- Short-Circuit Rated

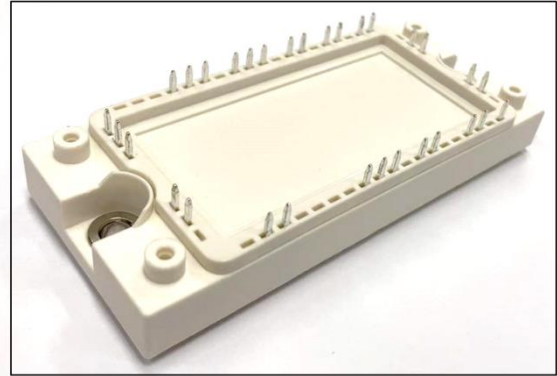


Product Summary

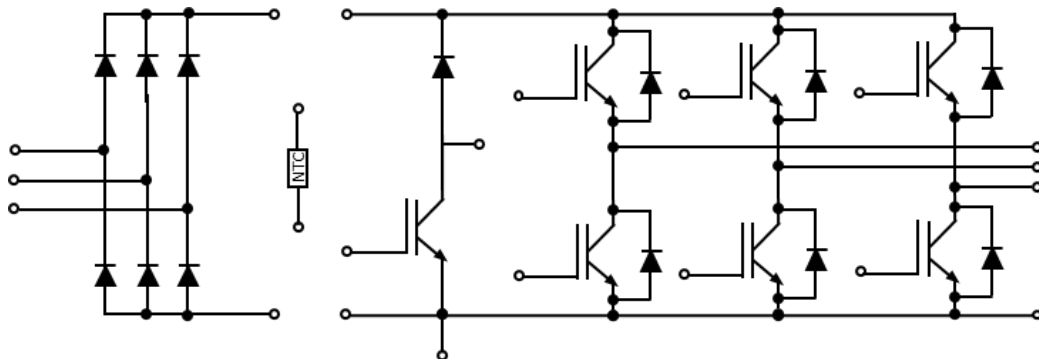
V_{CES}	1200V
I_C	75A
$V_{CE(sat),typ}$	1.55V

Applications

- General Purpose Inverters
- Frequency Converters
- Industrial Motor Drives
- Servos



Internal Connection



• IGBT, Inverter

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Collector-to-Emitter Voltage	V_{CES}	1200	V
Gate-to-Emitter Voltage	V_{GES}	± 20	
Transient Gate-emitter Voltage ($t_p \leq 10\mu s$, $D < 0.010$)		± 30	
Continuous DC Collector Current ($T_C = 120^\circ C$, $T_J = 175^\circ C$)	I_{CDC}	75	A
Repetitive Peak Collector Current ($t_p = 1ms$)	I_{CRM}	150	

Electrical Characteristics ^{(1), (2)}

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector-to-Emitter Breakdown Voltage	BV_{CES}	$V_{GE} = 0V, I_C = 250\mu A$	1200	-	-	V
Collector-to-Emitter Leakage Current	I_{CES}	$V_{CE} = 1200V, V_{GE} = 0V$	-	-	5	mA
Gate-to-Emitter Leakage Current	I_{GES}	$V_{CE} = 0V, V_{GE} = \pm 20V$	-	-	400	nA
Gate Threshold Voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 1.5mA$	5.5	6.5	7.5	V
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 15V, I_C = 75A$	-	1.55	1.9	
		$V_{GE} = 15V, I_C = 75A, T_J = 150^\circ C$	-	1.95	-	
		$V_{GE} = 15V, I_C = 75A, T_J = 175^\circ C$	-	2.05	-	
Total Gate Charge	Q_g	$V_{CC} = 600V, V_{GE} = 0/15V, I_C = 75A$	-	0.33	-	μC
Internal Gate Resistance	R_{Gint}	-	-	4.0	-	Ω
Input Capacitance	C_{iss}	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$	-	7.33	-	nF
Output Capacitance	C_{oss}		-	0.29	-	
Reverse Transfer Capacitance	C_{rss}		-	0.1	-	
Turn-on Delay time	$t_{d(ON)}$	$V_{CC} = 600V, V_{GE} = \pm 15V, R_G = 1\Omega, I_C = 75A, L_{load} = 0.82mH, \text{Energy losses include "tail" and diode reverse recovery.}$	-	98	-	ns
Rise Time	t_r		-	18	-	
Turn-off Delay time	$t_{d(OFF)}$		-	234	-	
Fall Time	t_f		-	245	-	
Turn-On Switching Loss	E_{on}	$V_{CC} = 600V, V_{GE} = \pm 15V, R_G = 1\Omega, I_C = 75A, L_{load} = 0.82mH, \text{Energy losses include "tail" and diode reverse recovery.}$	-	3.7	-	mJ
Turn-Off Switching Loss	E_{off}		-	5.2	-	
IGBT Total Switching Loss	E_{ts}		-	8.9	-	
Turn-on Delay time	$t_{d(ON)}$	$V_{CC} = 600V, V_{GE} = \pm 15V, R_G = 1\Omega, I_C = 75A, L_{load} = 0.82mH, \text{Energy losses include "tail" and diode reverse recovery.}$ $T_J = 150^\circ C$	-	102	-	ns
Rise Time	t_r		-	24	-	
Turn-off Delay time	$t_{d(OFF)}$		-	299	-	
Fall Time	t_f		-	373	-	
Turn-On Switching Loss	E_{on}		-	8.3	-	mJ
Turn-Off Switching Loss	E_{off}		-	8.2	-	
IGBT Total Switching Loss	E_{ts}		-	16.5	-	
Short Circuit Collector Current	$I_{C(SC)}$	$V_{GE} = 15V, V_{CC} \leq 600V, t_{SC} \leq 10\mu s$	-	325	-	A

• Diode, Inverter

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	1200	V
Continuous DC Forward Current ($T_C = 100^\circ\text{C}$, $T_J = 175^\circ\text{C}$)	I_F	75	A
Repetitive Peak Forward Current ($t_p = 1\text{ms}$)	I_{FRM}	150	

Electrical Characteristics ⁽¹⁾

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Diode Forward Voltage	V_F	$I_F = 75\text{A}$	-	1.8	2.5	V
		$I_F = 75\text{A}$ $T_J = 150^\circ\text{C}$	-	1.6	-	
		$I_F = 75\text{A}$ $T_J = 175^\circ\text{C}$	-	1.55	-	
Diode Reverse-Recovery Charge	Q_{rr}	$V_R = 600\text{V}$, $I_F = 75\text{A}$, $dI_F/dt = -2830\text{ A}/\mu\text{s}$	-	5.4	-	μC
Diode Peak Reverse-Recovery Current	I_{rrm}		-	79	-	A
Diode Reverse-Recovery Loss	E_{rr}		-	1.9	-	mJ

• IGBT, Brake-Chopper

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Collector-to-Emitter Voltage	V_{CES}	1200	V
Gate-to-Emitter Voltage	V_{GES}	± 20	
Transient Gate-emitter Voltage ($t_p \leq 10\mu\text{s}$, $D < 0.010$)		± 30	
Continuous DC Collector Current ($T_C = 100^\circ\text{C}$, $T_J = 175^\circ\text{C}$)	I_{CDC}	50	A
Repetitive Peak Collector Current ($t_p = 1\text{ms}$)	I_{CRM}	100	

Electrical Characteristics ^{(1), (2)}

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Collector-to-Emitter Breakdown Voltage	BV_{CES}	$V_{GE} = 0\text{V}$, $I_C = 250\mu\text{A}$	1200	-	-	V
Collector-to-Emitter Leakage Current	I_{CES}	$V_{CE} = 1200\text{V}$, $V_{GE} = 0\text{V}$	-	-	5	mA
Gate-to-Emitter Leakage Current	I_{GES}	$V_{CE} = 0\text{V}$, $V_{GE} = \pm 20\text{V}$	-	-	100	nA

Gate Threshold Voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}, I_C = 1.5mA$	5.5	6.5	7.5	
Collector-to-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE} = 15V, I_C = 50A$	-	1.7	2.0	V
		$V_{GE} = 15V, I_C = 50A,$ $T_J = 125^{\circ}C$	-	2.05	-	
		$V_{GE} = 15V, I_C = 50A,$ $T_J = 150^{\circ}C$	-	2.15	-	
Total Gate Charge	Q_g	$V_{CC} = 600V,$ $V_{GE} = 15V,$ $I_C = 50A$	-	220	-	nC
Input Capacitance	C_{iss}	$V_{CE} = 25V,$ $V_{GE} = 0V,$ $f = 1MHz$	-	4150	-	pF
Output Capacitance	C_{oss}		-	230	-	
Reverse Transfer Capacitance	C_{rss}		-	54	-	
Turn-on Delay time	$t_{d(ON)}$	$V_{CC} = 600V,$ $V_{GE} = \pm 15V,$ $R_G = 10\Omega,$ $I_C = 50A,$ $L_{load} = 0.82mH,$ Energy losses include "tail" and diode reverse recovery.	-	41	-	ns
Rise Time	t_r		-	26	-	
Turn-off Delay time	$t_{d(OFF)}$		-	207	-	
Fall Time	t_f		-	127	-	
Turn-On Switching Loss	E_{on}		-	2.6	-	mJ
Turn-Off Switching Loss	E_{off}	$V_{CC} = 600V,$ $V_{GE} = \pm 15V,$ $R_G = 10\Omega,$ $I_C = 50A,$ $L_{load} = 0.82mH,$ Energy losses include "tail" and diode reverse recovery. $T_J = 150^{\circ}C$	-	2.0	-	
IGBT Total Switching Loss	E_{ts}		-	4.6	-	ns
Turn-on Delay time	$t_{d(ON)}$		-	36	-	
Rise Time	t_r		-	28	-	
Turn-off Delay time	$t_{d(OFF)}$		-	204	-	
Fall Time	t_f		-	186	-	mJ
Turn-On Switching Loss	E_{on}		-	4.2	-	
Turn-Off Switching Loss	E_{off}		-	3.2	-	
IGBT Total Switching Loss	E_{ts}		-	7.4	-	

• Diode, Brake-Chopper

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	1200	V
Continuous DC Forward Current ($T_C = 100^{\circ}C, T_J = 175^{\circ}C$)	I_F	35	A
Repetitive Peak Forward Current ($t_P = 1ms$)	I_{FRM}	70	

Electrical Characteristics ⁽¹⁾

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Diode Forward Voltage	V_F	$I_F = 35A$	-	2.0	2.6	V
		$I_F = 35A$ $T_J = 125^{\circ}C$	-	1.75	-	
		$I_F = 35A$ $T_J = 150^{\circ}C$	-	1.7	-	
Diode Reverse-Recovery Charge	Q_{rr}	$V_R = 600V, I_F = 35A,$ $dI_F/dt = -1590 A/\mu s$	-	2.46	-	μC
Diode Peak Reverse-Recovery Current	I_{rrm}		-	34	-	A
Diode Reverse-Recovery Loss	E_{rr}		-	0.84	-	mJ

- **Diode, Rectifier**

Absolute Maximum Ratings ⁽¹⁾

Parameter	Symbol	Limit	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	1600	V
Average Output Current 50/60Hz,sine wave ($T_C = 100^{\circ}C$)	$I_{F(AV)}$	75	A
Surge Forward Current ($V_R = 0, t_p = 10ms, T_J = 25^{\circ}C$)	I_{FSM}	600	
I^2t – value ($V_R = 0, t_p = 10ms$)	I^2t	1800	A^2s

Electrical Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Diode Forward Voltage	V_F	$I_F = 75A$ $T_J = 150^{\circ}C$	-	1.0	-	V
Diode Threshold Voltage	V_{TO}	$T_J = 150^{\circ}C$	-	0.8	-	
Diode Slope Resistance	r_T	$T_J = 150^{\circ}C$	-	2.7	-	$m\Omega$
Diode Reverse Current	I_R	$V_R = 1600V$ $T_J = 150^{\circ}C$	-	-	4.0	mA

- **NTC thermistors**

Characteristics

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Rated Resistance	R_{25}	-	-	5.0	-	$k\Omega$
Deviation of R100	$\Delta R/R$	$T_C = 100^{\circ}C$ $R_{100} = 493\Omega$	-5	-	5	%
Power Dissipation	P_{25}	-	-	-	20.0	mW
B-value	$B_{25/50}$	$R_2 = R_{25} \exp [B_{25/50}(1/T_2 - 1/(298.15 K))]$	-	3375	-	K

• Module

Absolute Maximum Ratings

Parameter	Symbol	Limit	Unit
Maximum Junction Temperature	T_j	-40 to +175	°C
Operating Junction Temperature	$T_{vj\ op}$	-40 to +150	
Storage Temperature	T_{stg}	-40 to +125	
Isolation Voltage (RMS, $f = 50\text{Hz}$, $t = 1\text{min}$)	V_{iso}	2.5	kV

Characteristics

Parameter	Symbol	Min	Typ	Max	Unit
Stray Inductance-module	L_{sCE}	-	35	-	nH
Module Lead Resistance, Terminal to Chip	$R_{CC'+EE'}$	-	4.0	-	mΩ
Module Lead Resistance, Terminal to Chip	$R_{AA'+CC'}$	-	3.0	-	
Junction-to-Case Thermal Resistance, per IGBT, Inverter	$R_{\theta JC}$	-	0.28	-	°C/W
Junction-to-Case Thermal Resistance, per Diode, Inverter		-	0.53	-	
Junction-to-Case Thermal Resistance, per IGBT, Brake-Chopper		-	0.46	-	
Junction-to-Case Thermal Resistance, per Diode, Brake-Chopper		-	0.97	-	
Junction-to-Case Thermal Resistance, per Diode, Rectifier		-	0.53	-	
Case-to-Heatsink Thermal Resistance, per IGBT, Inverter	$R_{\theta CH}$	-	0.14	-	°C/W
Case-to-Heatsink Thermal Resistance, per Diode, Inverter		-	0.27	-	
Case-to-Heatsink Thermal Resistance, per IGBT, Brake-Chopper		-	0.23	-	
Case-to-Heatsink Thermal Resistance, per Diode, Brake-Chopper		-	0.47	-	
Case-to-Heatsink Thermal Resistance, per Diode, Rectifier		-	0.29	-	
Case-to-Heatsink Thermal Resistance, per Module		-	0.01	-	
Module-to-Sink Torque	M_s	3.0	-	6.0	Nm
Weight per Module	G	-	180	-	g

(1) $T_j = 25^\circ\text{C}$ unless otherwise specified

(2) t_r : from 10% of I_C to 90% of I_C ; t_f : from 90% of I_C to 10% of I_C ;

E_{on} : from 10% of V_{GE} to 10% of V_{CE} ; E_{off} : from 90% of V_{GE} to 10% of I_C .

• **Typical Electrical Characteristics**

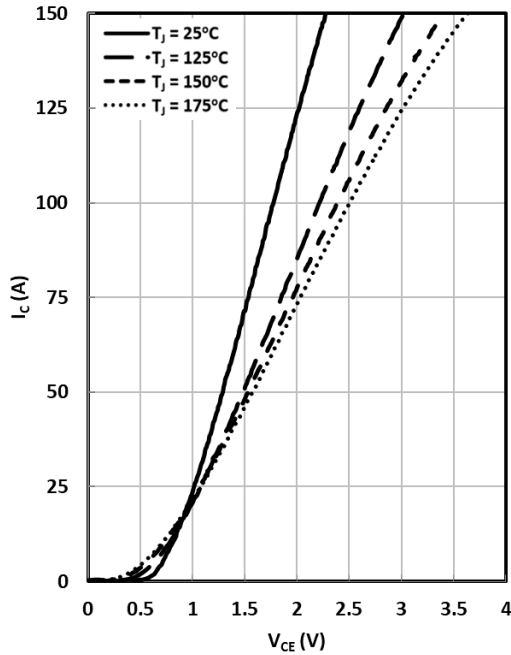


Fig. 1 IGBT (Inverter) output characteristics

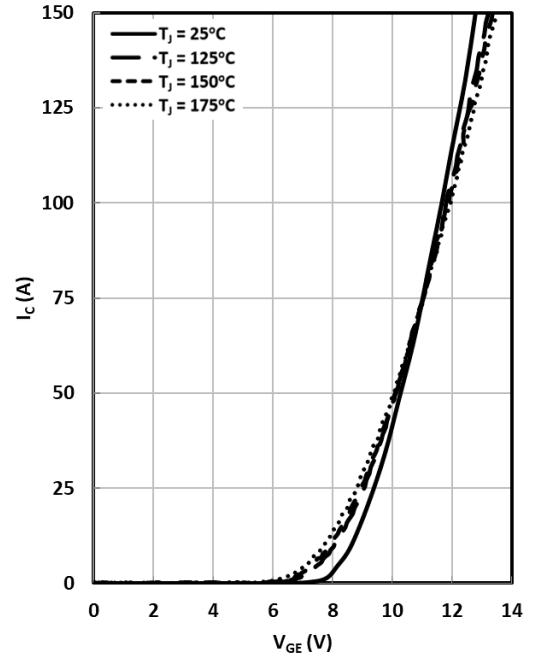


Fig. 2 IGBT (Inverter) transfer characteristics

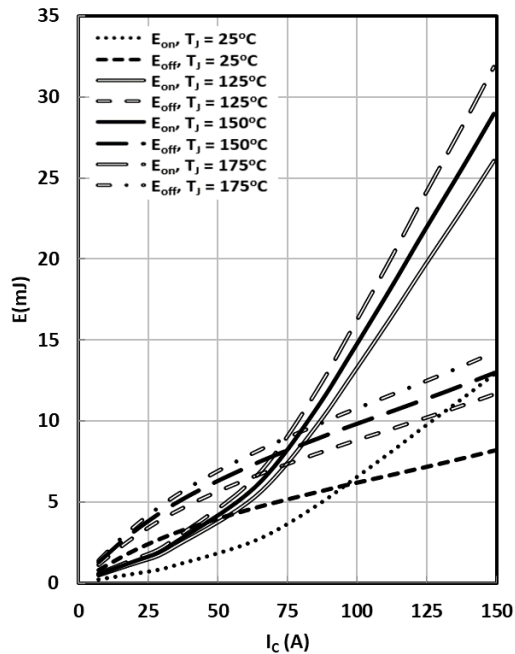


Fig. 3 IGBT (Inverter) switching loss vs. I_C

($V_{CC} = 600V$, $V_{GE} = \pm 15V$, $R_G = 1\Omega$)

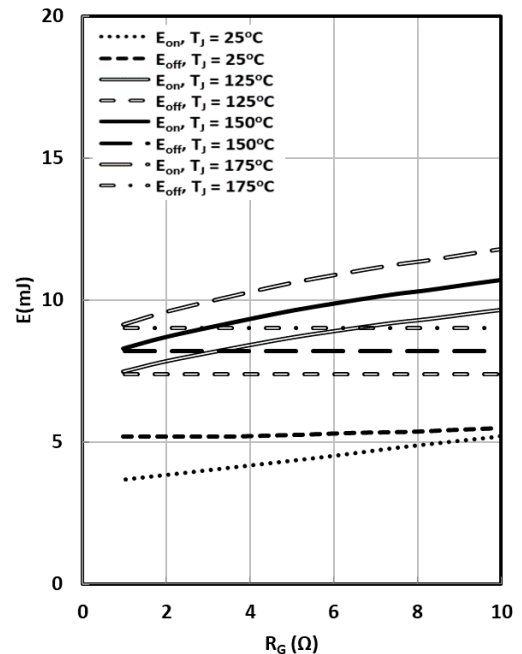


Fig. 4 IGBT (Inverter) switching loss vs. R_G

($V_{CC} = 600V$, $V_{GE} = \pm 15V$, $I_C = 75A$)

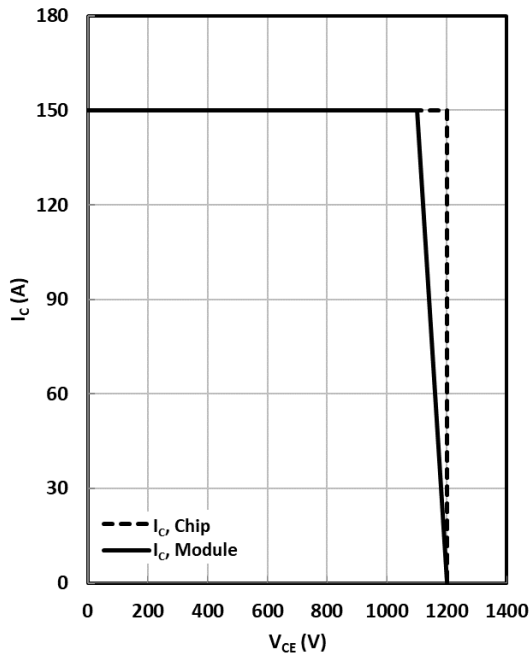


Fig. 5 RBSOA

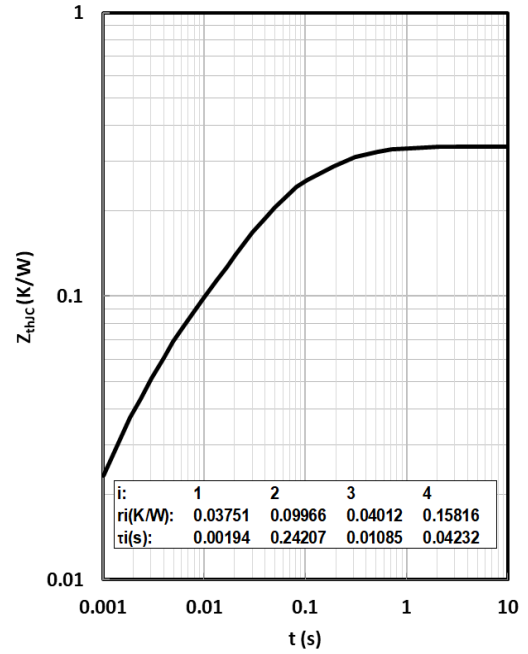


Fig. 6 IGBT (Inverter) transient thermal impedance

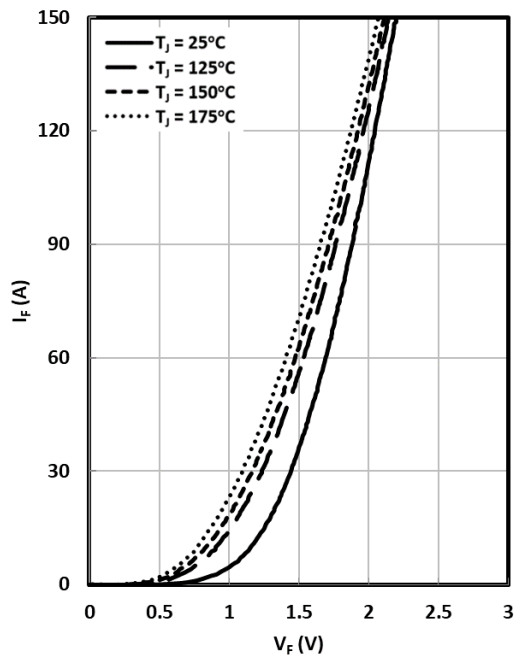


Fig. 7 Diode (Inverter) output characteristics

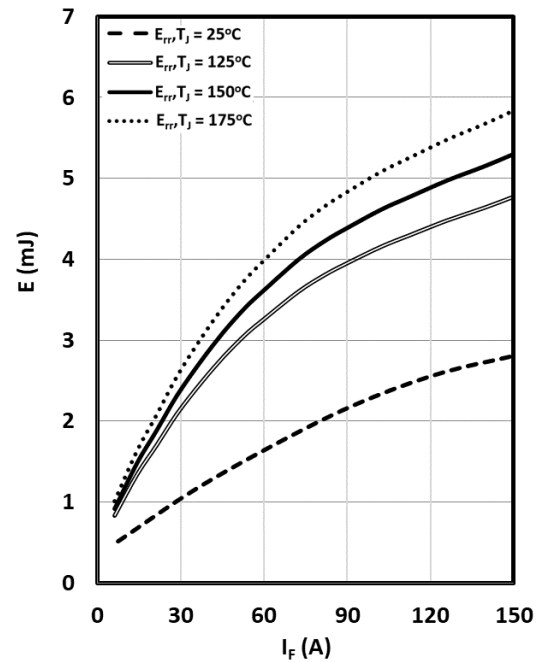


Fig. 8 Diode (Inverter) switching loss vs. I_F

($V_{CC} = 600V$, $R_G = 1\Omega$)

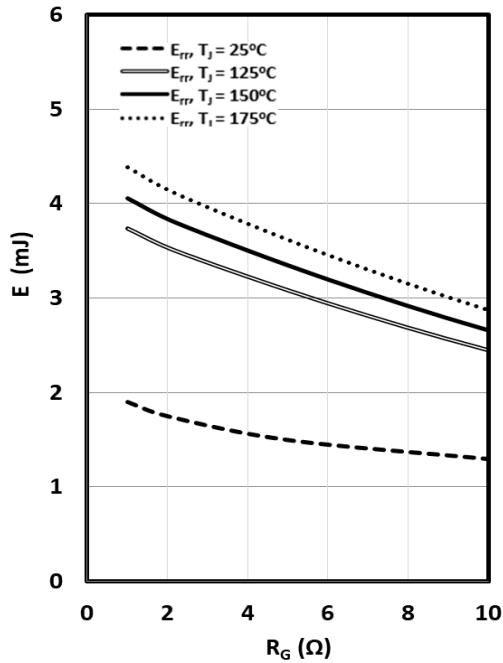


Fig. 9 Diode (Inverter) switching loss vs. R_G
($V_{CC} = 600V$, $I_F = 75A$)

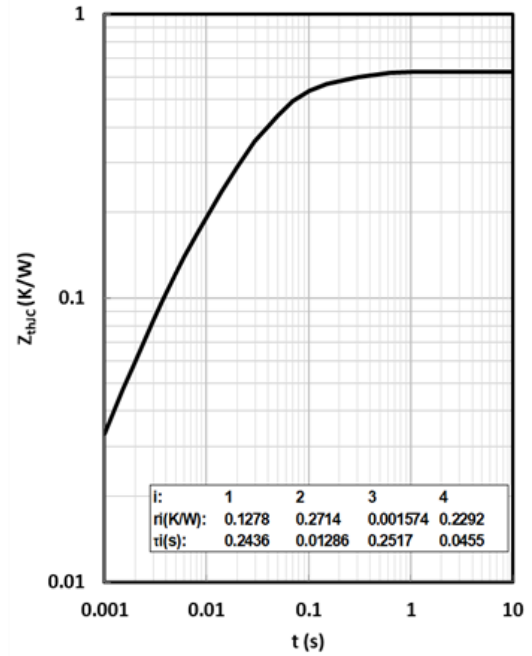


Fig. 10 Diode (Inverter) transient thermal impedance

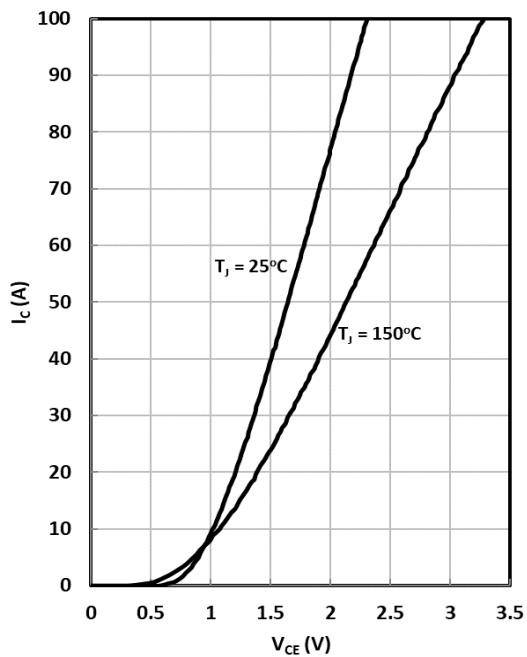


Fig. 11 IGBT (Brake-Chopper) output characteristics

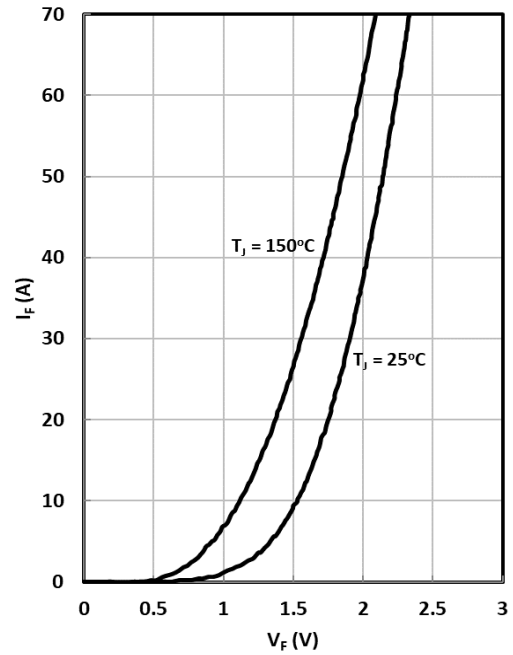


Fig. 12 Diode (Brake-Chopper) output characteristics

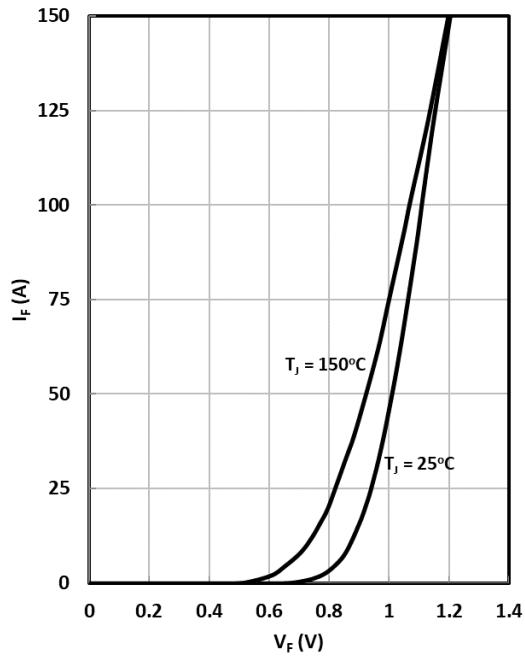


Fig. 13 Diode (Rectifier) output characteristics

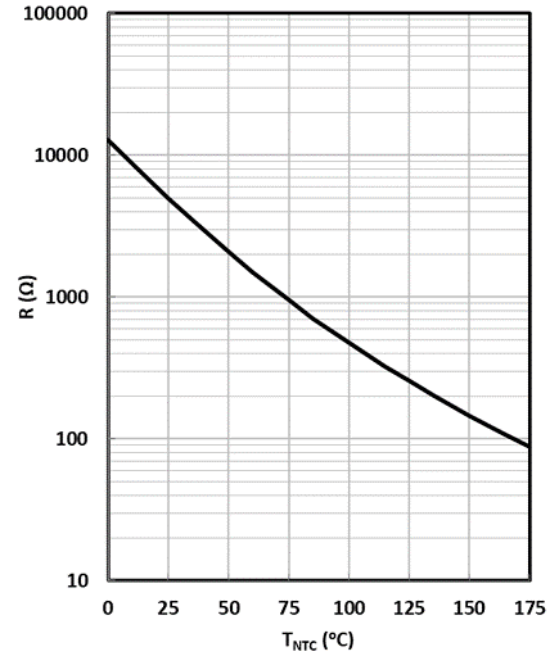
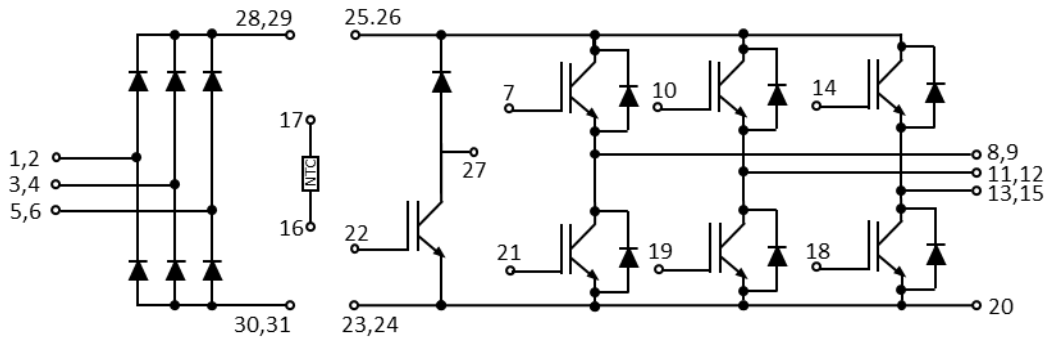
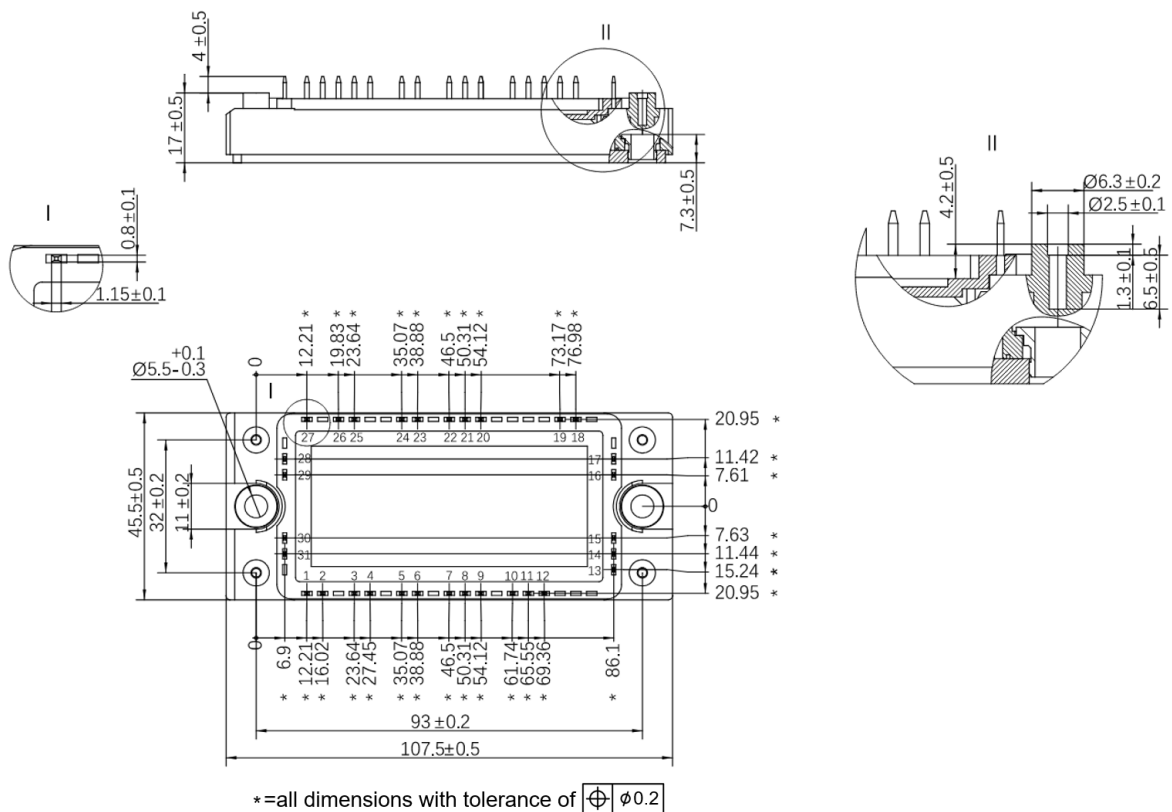


Fig. 14 NTC temperature characteristics

Circuit diagram



Package Dimensions



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